

HRD85N08K

80V N-Channel Trench MOSFET

Features

- Low Dense Cell Design
- Reliable and Rugged
- Advanced Trench Process Technology
- 100% UIS Tested, 100% Rg Tested

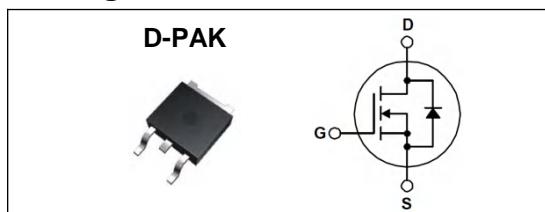
Key Parameters

Parameter	Value	Unit
BV _{DSS}	80	V
I _D (Silicon Limited)	110	A
R _{DS(on), typ}	7	mΩ

Application

- Power Management in Inverter System
- Synchronous Rectification

Package & Internal Circuit



Absolute Maximum Ratings

T_J=25°C unless otherwise specified

Symbol	Parameter	Value	Units
V _{DSS}	Drain-Source Voltage	80	V
V _{GS}	Gate-Source Voltage	±25	V
I _D	Drain Current (Silicon Limited)	T _C = 25 °C	A
		T _C = 100 °C	A
	Drain Current (Package Limited)	T _C = 25 °C	A
I _{DM}	Pulsed Drain Current	385	A
E _{AS}	Single Pulsed Avalanche Energy L=1mH	290	mJ
P _D	Power Dissipation	T _C = 25 °C	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C

Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Units
R _{θJC}	Junction-to-Case	--	0.75	°C/W
R _{θJA}	Junction-to-Ambient (minimum pad of 2 oz copper)	--	110	°C/W
R _{θJA}	Junction-to-Ambient (* 1 in ² pad of 2 oz copper)	--	50	°C/W

Electrical Characteristics $T_J=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
On Characteristics						
V_{GS}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	2.2	--	3.8	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$, $I_D = 30 \text{ A}$	--	7.0	8.5	$\text{m}\Omega$
g_{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}$, $I_D = 30 \text{ A}$	--	42	--	S
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	80	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 64 \text{ V}$, $V_{GS} = 0 \text{ V}$	--	--	1	μA
		$V_{DS} = 64 \text{ V}$, $T_J = 125^\circ\text{C}$	--	--	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 25 \text{ V}$, $V_{DS} = 0 \text{ V}$	--	--	± 100	nA
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$	--	3200	--	pF
C_{oss}	Output Capacitance		--	440	--	pF
C_{rss}	Reverse Transfer Capacitance		--	270	--	pF
R_g	Gate Resistance	$V_{GS} = 0 \text{ V}$, $V_{DS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	--	1.2	--	Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Time	$V_{DS} = 40 \text{ V}$, $I_D = 30 \text{ A}$, $R_G = 6 \Omega$	--	50	--	ns
t_r	Turn-On Rise Time		--	65	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	140	--	ns
t_f	Turn-Off Fall Time		--	50	--	ns
Q_g	Total Gate Charge	$V_{DS} = 64 \text{ V}$, $I_D = 30 \text{ A}$, $V_{GS} = 10 \text{ V}$	--	75	--	nC
Q_{gs}	Gate-Source Charge		--	20	--	nC
Q_{gd}	Gate-Drain Charge		--	25	--	nC
Source-Drain Diode Characteristics						
V_{SD}	Source-Drain Diode Forward Voltage	$I_S = 30 \text{ A}$, $V_{GS} = 0 \text{ V}$	--	--	1.3	V
trr	Reverse Recovery Time	$I_S = 30 \text{ A}$, $V_{GS} = 0 \text{ V}$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$	--	45	--	ns
Qrr	Reverse Recovery Charge		--	65	--	nC

Typical Characteristics

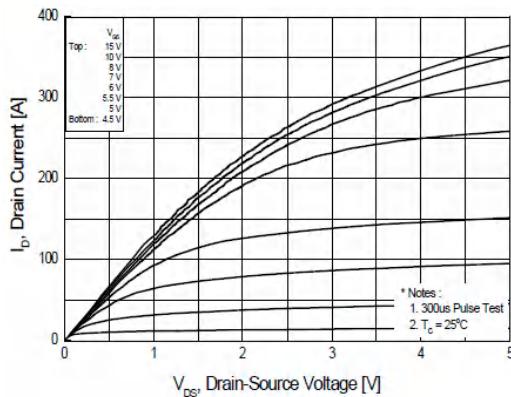


Figure 1. On Region Characteristics

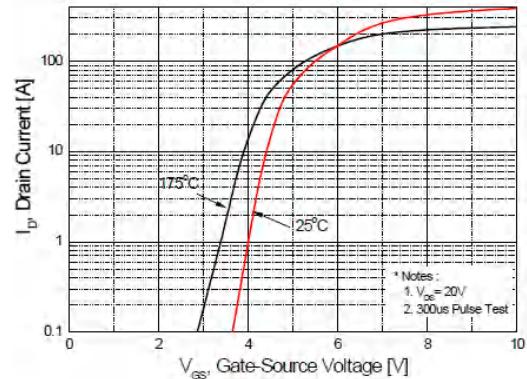


Figure 2. Transfer Characteristics

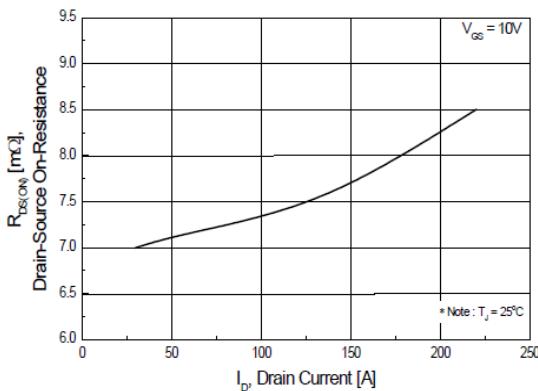


Figure 3. On Resistance Variation vs. Drain Current and Gate Voltage

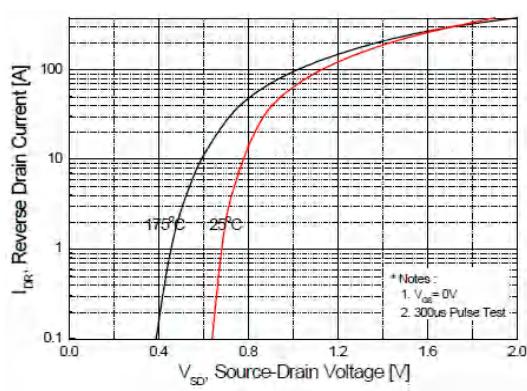


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

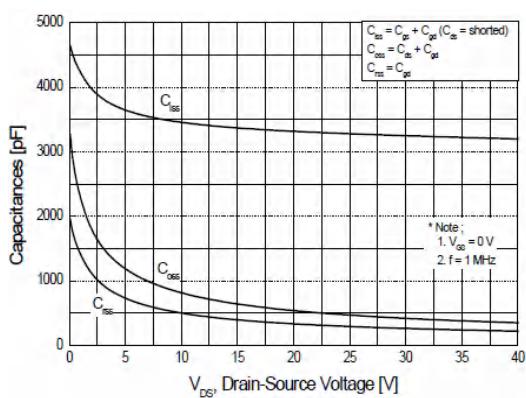


Figure 5. Capacitance Characteristics

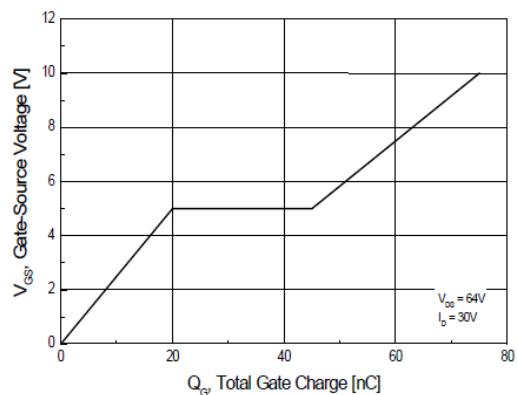


Figure 6. Gate Charge Characteristics

Typical Characteristics (continued)

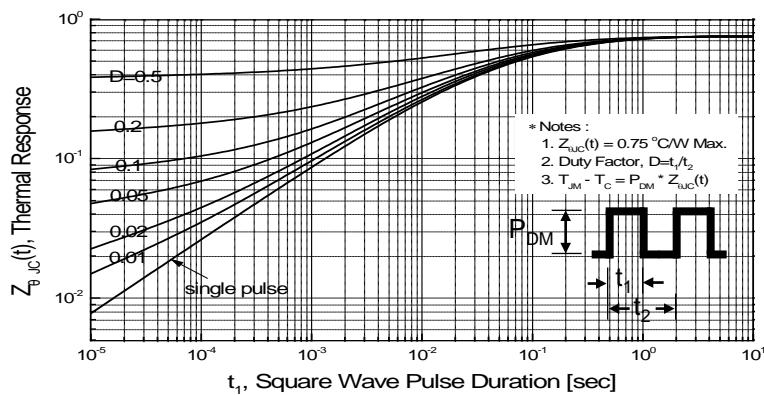
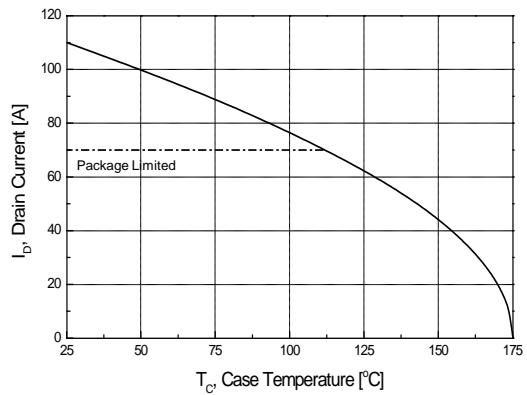
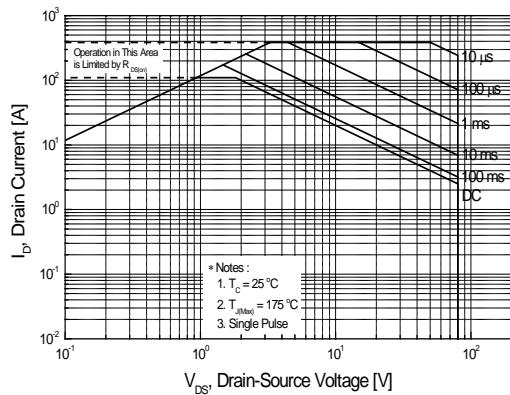
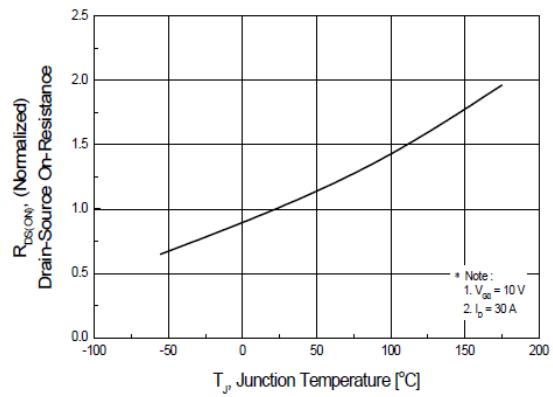
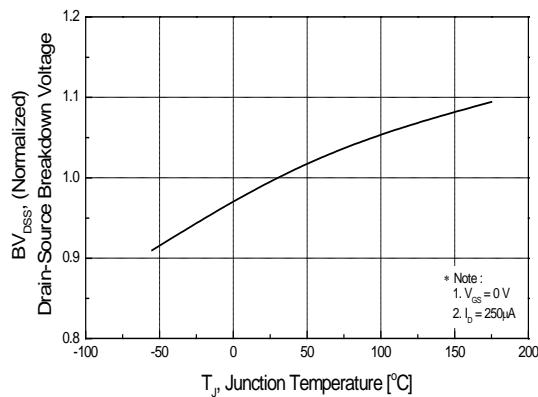


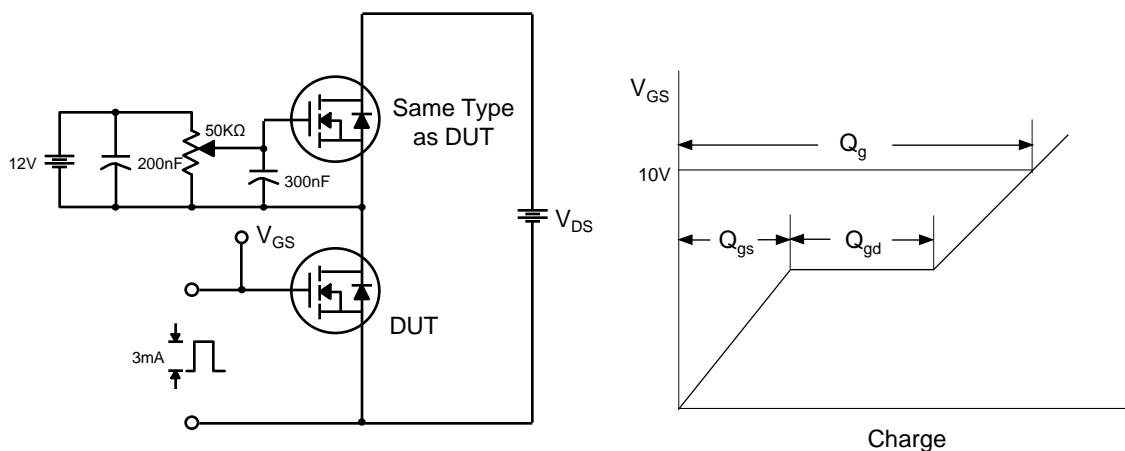
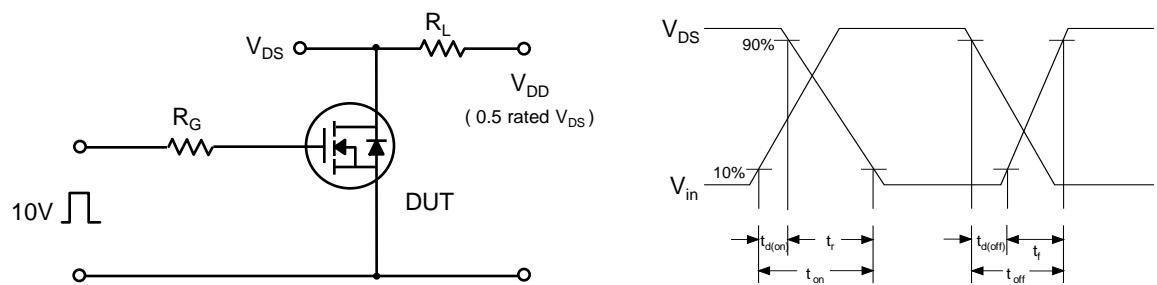
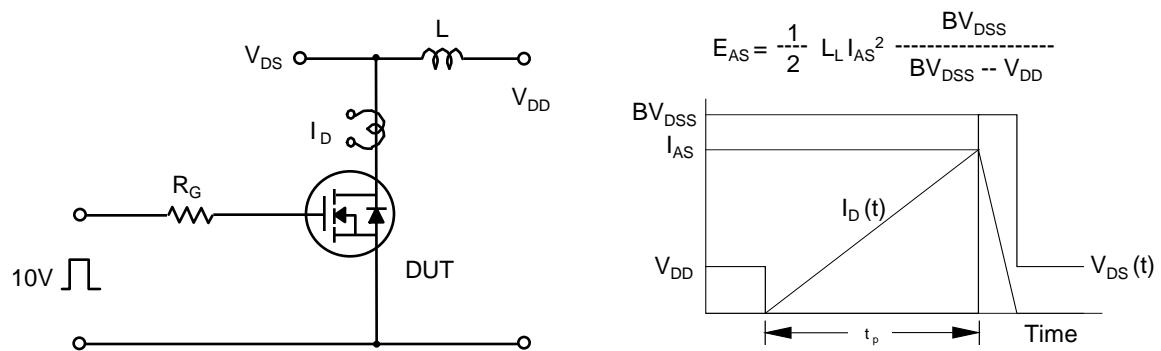
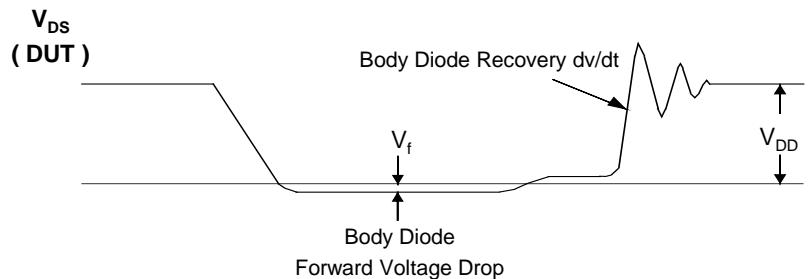
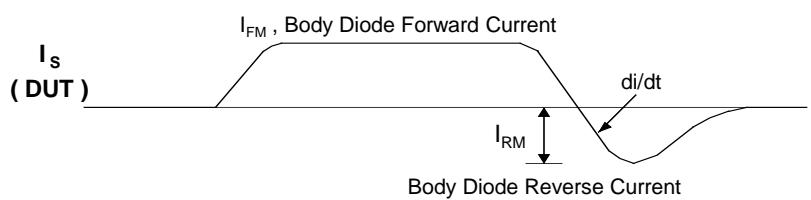
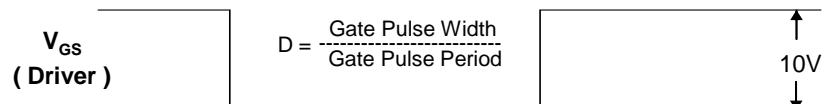
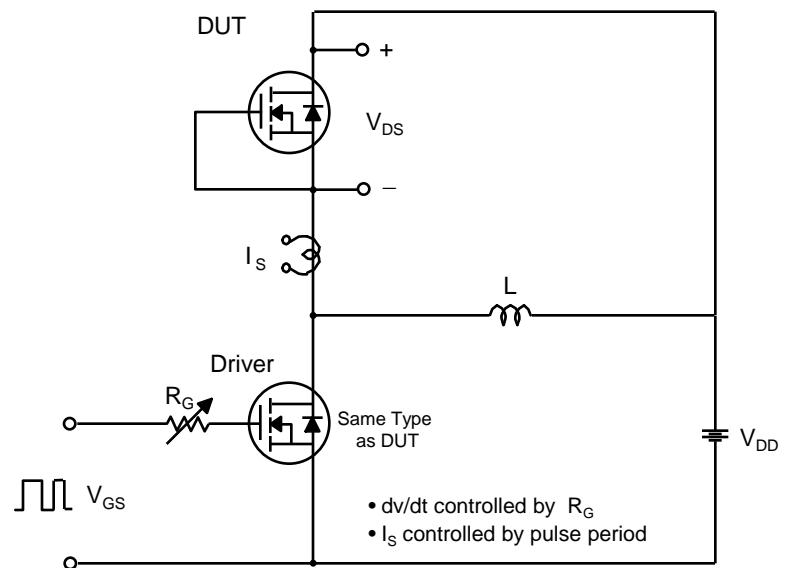
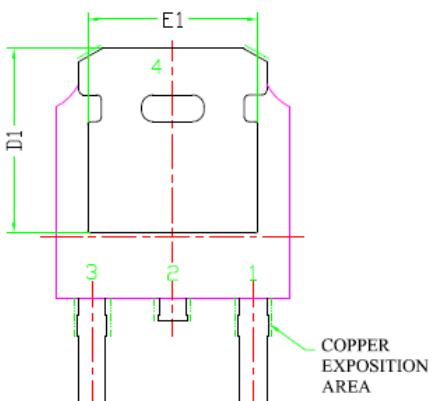
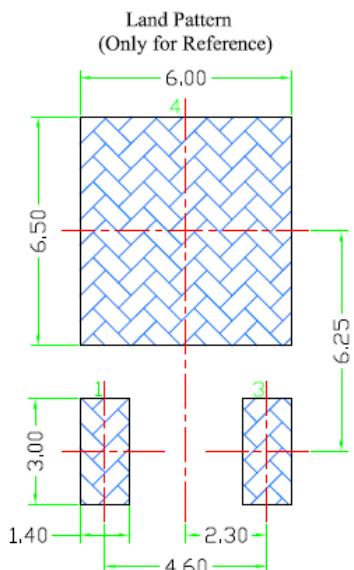
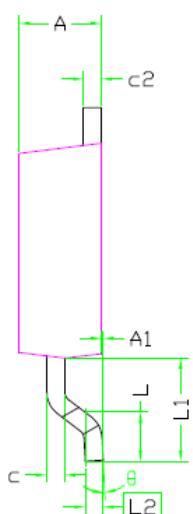
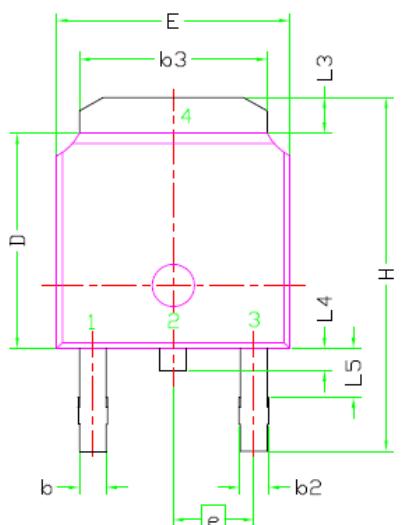
Fig 12. Gate Charge Test Circuit & Waveform**Fig 13. Resistive Switching Test Circuit & Waveforms****Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms**

Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimension

D-PAK
(TO-252A)



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
E	6.40	6.60	6.731
L	1.40	1.52	1.77
L1		2.743	REF
L2		0.508	BSC
L3	0.89	--	1.27
L4	0.64	--	1.01
L5	--	--	--
D	6.00	6.10	6.223
H	9.40	10.00	10.40
b	0.64	0.76	0.88
b2	0.77	0.84	1.14
b3	5.21	5.34	5.46
e		2.286	BSC
A	2.20	2.30	2.38
A1	0	--	0.127
c	0.45	0.50	0.60
c2	0.45	0.50	0.58
D1	5.21	--	--
E1	4.40	--	--
θ	0°	--	10°